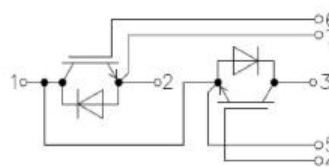


Features

- Trench/Fieldstop IGBT
- Half-bridge
- Standard package
- High short circuit capability
- Including anti-parallel FWD



Application

- Frequency converter
- UPS
- High Power Converters
- Motor Drives
- Wind Turbines



Halogen-Free

IGBT, Inverter

Absolute Maximum Ratings (TC=25°C unless otherwise noted)				
Symbol	Parameter		Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)				
V _{CES}	Collector Emitter Voltage	T _J =25°C	1200	V
V _{GES}	Gate Emitter Voltage		±20	V
I _C	DC Collector Current	T _C =100°C, T _{Jmax} =175°C	400	A
I _{CRM}	Repetitive peak collector current	tp=1ms	800	A
t _{SC}	Short circuit withstand time	V _{GE} =15V, V _{CC} =600V, T _{vj} ≤150°C	10	us
P _{tot}	Power Dissipation Per IGBT	T _C =25°C, T _{Jmax} =175°C	2419	W

Diode, Inverter

Absolute Maximum Ratings (TC=25°C unless otherwise noted)				
Symbol	Parameter		Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)				
V _{RRM}	Repetitive Reverse Voltage	T _J =25°C	1200	V
I _F	Forward current,DC		400	A
I _{FRM}	Repetitive peak forward current	tp=1ms	800	A

IGBT, Inverter

Electrical Characteristics (TC=25°C unless otherwise noted)								
Symbol	Parameter	Condition		Min	Typ	Max	Unit	
Static Electrical Characteristics @ TC= 25°C (unless otherwise stated)								
V _{GE(th)}	Gate Emitter Threshold Voltage	V _{CE} =V _{GE} , I _C =16mA		5.2	5.7	6.4	V	
V _{CE(sat)}	Collector - Emitter Saturation Voltage	I _C =400A, V _{GE} =15V, T _J =25°C		--	1.65	--	V	
		I _C =400A, V _{GE} =15V, T _J =125°C		--	1.90	--	V	
		I _C =400A, V _{GE} =15V, T _J =150°C		--	1.93	--	V	
I _{CES}	Collector Leakage Current	V _{CE} =1200V, V _{GE} =0V, T _J =25°C		--	--	1.0	mA	
I _{GES}	Gate Leakage Current	V _{CE} =0V,V _{GE} =±20V, T _J =25°C		--	--	250	nA	
Q _g	Gate Charge	V _{CE} =600V, I _C =400A , V _{GE} =15V		--	4.1	--	μC	
C _{ies}	Input Capacitance	V _{CE} =25V, V _{GE} =0V, f =1MHz		--	43.6	--	nF	
C _{res}	Reverse Transfer Capacitance			--	1.4	--	nF	
R _g	Internal gate resistance	T _J =25°C		--	0.43	--	Ω	
t _{d(on)}	Turn-on Delay Time	V _{CC} =600V,I _C =400A R _{G(on)} =5.1Ω,R _{G(off)} =5.1Ω V _{GE} =±15V, Lload=100uH di/dt=5390A/μs (Tvj=150°C) du/dt=2546V/μs (Tvj=150°C)	T _J =25°C	--	166	--	ns	
			T _J =125°C	--	156	--	ns	
			T _J =150°C	--	155	--	ns	
t _r	Turn-on Rise Time		T _J =25°C	--	163	--	ns	
			T _J =125°C	--	163	--	ns	
			T _J =150°C	--	169	--	ns	
t _{d(off)}	Turn-Off Delay Time		T _J =25°C	--	833	--	ns	
			T _J =125°C	--	924	--	ns	
			T _J =150°C	--	931	--	ns	
t _f	Turn-Off Fall Time		T _J =25°C	--	134	--	ns	
			T _J =125°C	--	270	--	ns	
			T _J =150°C	--	296	--	ns	
E _{on}	Turn on Energy		T _J =25°C		67.7		mJ	
			T _J =150°C	--	93.3	--	mJ	
E _{off}	Turn off Energy	V _{CC} =600V,I _C =200A R _{G(on)} =2.5Ω,R _{G(off)} =2.5Ω V _{GE} =±15V, Inductive Load	T _J =25°C	--	52.5	--	mJ	
			T _J =150°C	--	67.4	--	mJ	
R _{thCH}	Thermalresistance,case to heatsink (Per IGBT/λgrease=1W/(m·K))			--	--	--	K/W	
T _{vjop}	Temperature under switching conditions			-40	--	150	°C	
R _{thJC}	Junction to Case Thermal Resistance (Per IGBT)			--	0.062	--	K/W	

Diode, Inverter

Absolute Maximum Ratings (TC=25℃ unless otherwise)								
Symbol	Parameter			Min	Typ	Max	Unit	
Common Ratings (TC=25℃ Unless Otherwise Noted)								
V _F	Forward Voltage	I _F =400A , V _{GE} =0V, T _J =25℃		--	1.60	--	V	
		I _F =400A , V _{GE} =0V, T _J =125℃		--	1.35	--		
		I _F =400A , V _{GE} =0V, T _J =150℃		--	1.30	--		
t _{rr}	Reverse Recovery Time		T _J =25℃	--	202	--	ns	
			T _J =125℃	--	388	--	ns	
			T _J =150℃	--	547	--	ns	
I _{RM}	Peak reverse recovery current		T _J =25℃	--	191	--	A	
			T _J =125℃	--	328	--	A	
			T _J =150℃	--	364	--	A	
Q _R	Recovered charge	I _F =400A , V _R =600V dI _F /dt=-4264A/μs T _J =150℃	T _J =25℃	--	30.1	--	μC	
			T _J =125℃	--	82.1	--	μC	
			T _J =150℃	--	101.9	--	μC	
E _{rec}	Reverse Recovery Energy		T _J =25℃	--	11.1	--	mJ	
			T _J =125℃	--	31.6	--	mJ	
			T _J =150℃	--	39.6	--	mJ	
T _{vjop}	Temperature under switching conditions			-40	--	150	℃	
R _{thJCD}	Junction to Case Thermal Resistance （Per Diode）			--	0.11	--	K/W	

Module

Absolute Maximum Ratings (TC=25℃ unless otherwise note)						
Symbol	Parameter		Rating			Unit
Common Ratings (TC=25℃ Unless Otherwise Noted)						
V _{ISOL}	Isolation voltage	Terminals to baseplate, RMS,f=50Hz,t=1min	4000			V
-	Material of module baseplate	-	Cu			
-	Internal isolation	Basic insulation(class 1, IEC 61140)	Al ₂ O ₃			
T _{stg}	Storage Temperature		-40~125			℃
Symbol	Parameter		Min	Typ	Max	Unit
M	Mounting torque for module mounting	Screw M6	3	-	6	Nm
	Terminal connection torque	Screw M6	2.5	-	5	Nm
ds	Creepage distance	Terminal to terminal	-	23	-	mm
		Terminal to base plate	-	29	-	mm
da	Clearance	Terminal to terminal	-	11	-	mm
		Terminal to base plate	-	23	-	
m	Weight			315		g

Typical Operating Characteristics

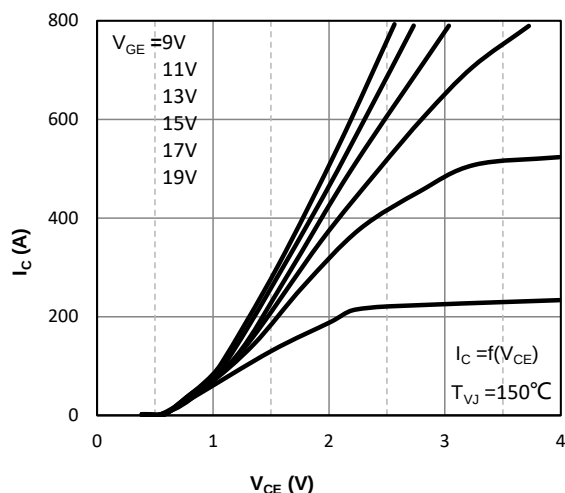


Figure 1. Typical Output Characteristics IGBT

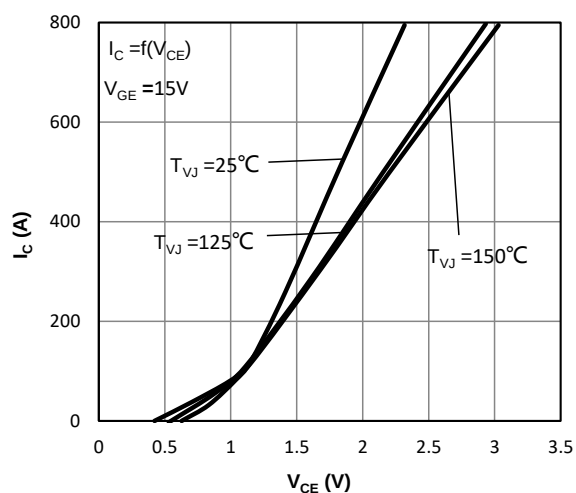


Figure 2. Typical Output Characteristics IGBT

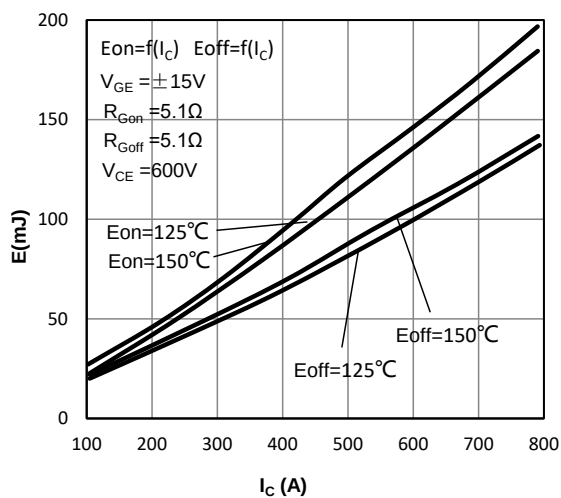


Figure 3. Typical Switching Losses IGBT

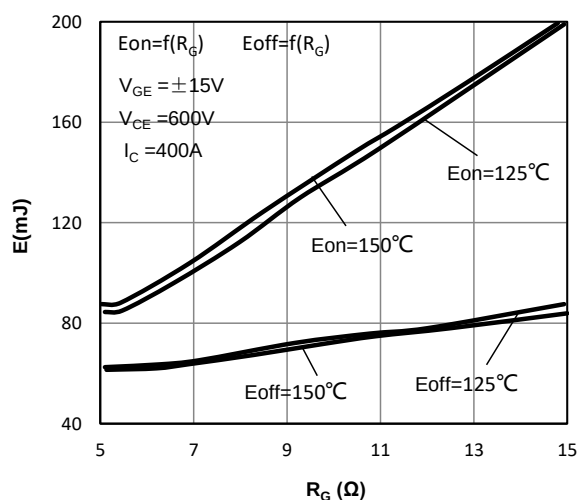


Figure 4. Typical Switching Losses IGBT

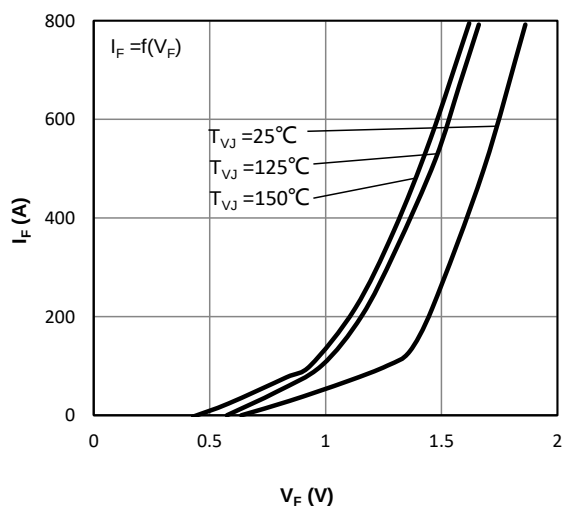


Figure 5. Typical Forward Characteristic of Diode

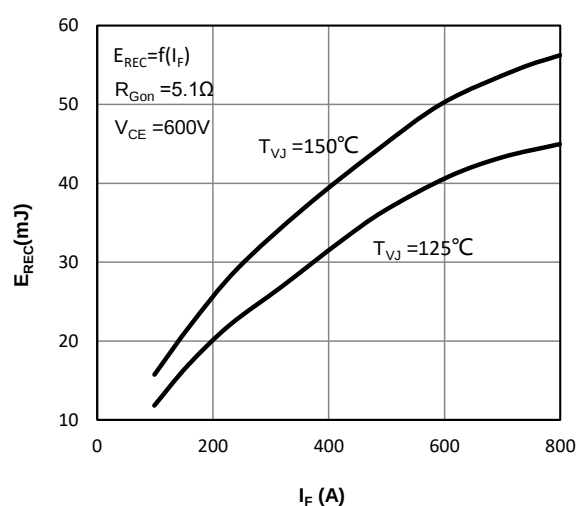


Figure 6. Typical Switching Losses Diode

Typical Operating Characteristics

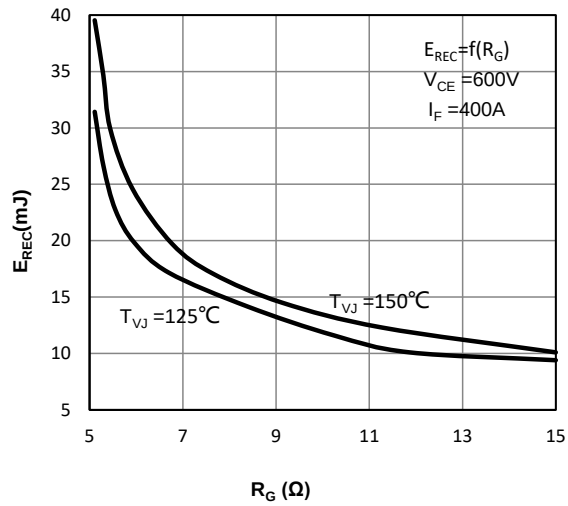
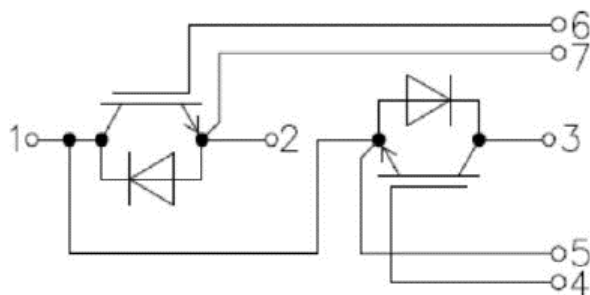


Figure 7. Typical Switching Losser Diode

Circuit diagram headline



Package outlines (Unit: mm)

